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In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

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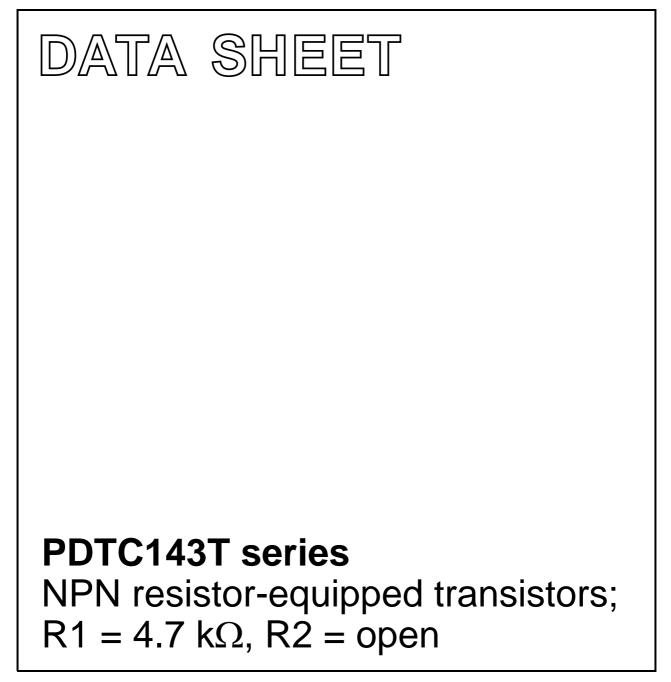
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2004 Apr 06 2004 Aug 06



PDTC143T series

FEATURES

- · Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- · General purpose switching and amplification
- Inverter and interface circuits
- Circuit applications.

PRODUCT OVERVIEW

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT	
V _{CEO}	collector-emitter voltage	-	50	V	
lo	output current (DC)	-	100	mA	
R1	bias resistor	4.7	-	kΩ	
R2	open	-	-	-	

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

TYPE NUMBER	PACKAGE		MARKING CODE	PNP COMPLEMENT	
ITPE NUMBER	PHILIPS	EIAJ	MARKING CODE		
PDTC143TE	SOT416	SC-75	40	PDTA143TE	
PDTC143TEF	SOT490	SC-89	11	PDTA143TEF	
PDTC143TK	SOT346	SC-59	52	PDTA143TK	
PDTC143TM	SOT883	SC-101	DM	PDTA143TM	
PDTC143TS	SOT54 (TO-92)	SC-43	TC143T	PDTA143TS	
PDTC143TT	SOT23	_	*33 ⁽¹⁾	PDTA143TT	
PDTC143TU	SOT323	SC-70	*52 ⁽¹⁾	PDTA143TU	

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$, R2 = open

PDTC143T series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

	SIMPLIFIED OUTLINE AND SYMBOL		PINNING		
TYPE NUMBER			DESCRIPTION		
PDTC143TS		1 2 3	base collector emitter		
PDTC143TE PDTC143TEF PDTC143TK PDTC143TT PDTC143TU	$\begin{array}{c} & & & \\ & & \\ & & \\ & & \\ 1 \\ & & \\ Top view \end{array}$	1 2 3	base emitter collector		
PDTC143TM	2 1 Bottom view MHC507 2 1 Bottom view	1 2 3	base emitter collector		

PDTC143T series

ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
	NAME	DESCRIPTION	VERSION	
PDTC143TE	-	plastic surface mounted package; 3 leads	SOT416	
PDTC143TEF	-	 plastic surface mounted package; 3 leads S0 		
PDTC143TK	-	 plastic surface mounted package; 3 leads SO 		
PDTC143TM	_	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5 \mbox{ mm}$		
PDTC143TS	 plastic single-ended leaded (through hole) package; 3 leads 		SOT54	
PDTC143TT	-	 plastic surface mounted package; 3 leads 		
PDTC143TU	_	plastic surface mounted package; 3 leads SOT32		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
lo	output current (DC)		_	100	mA
I _{CM}	collector current		-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT490	notes 1 and 2	_	250	mW
	SOT883	notes 2 and 3	_	250	mW
	SOT416	note 1	_	150	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μm copper strip line.

PDTC143T series

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W
	SOT416	note 1	833	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

CHARACTERISTICS

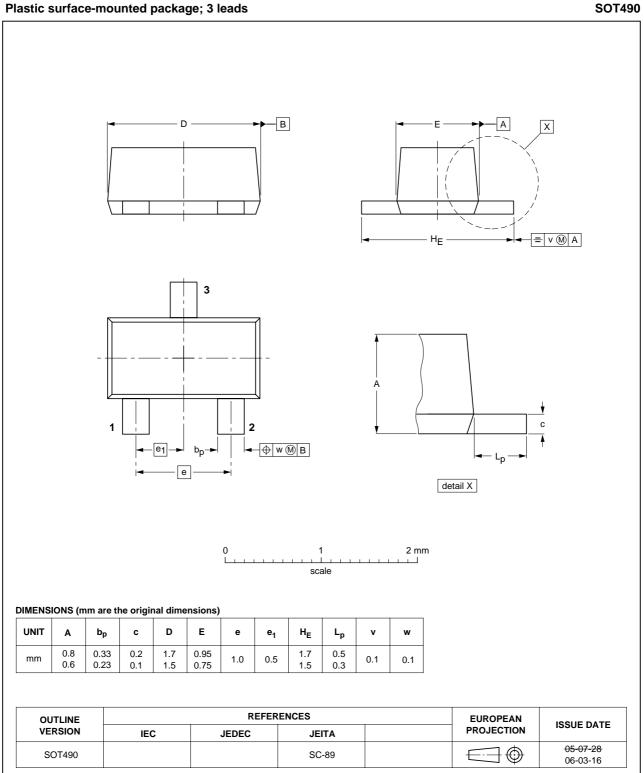
 T_{amb} = 25 °C unless otherwise specified.

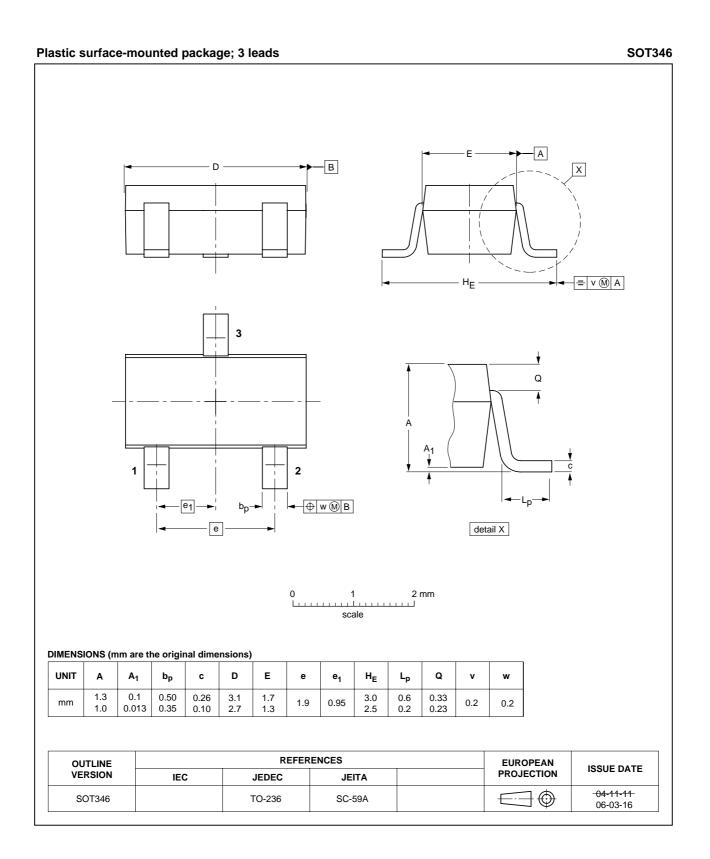
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0 A	-	-	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0 A	-	-	1	μA
		$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}; \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	-	50	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A	-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	200	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 5 mA; I _B = 0.25 mA	-	_	100	mV
R1	input resistor		3.3	4.7	6.1	kΩ
C _c	collector capacitance	$I_{E} = i_{e} = 0 \text{ A}; V_{CB} = 10 \text{ V};$ f = 1 MHz	-	-	2.5	pF

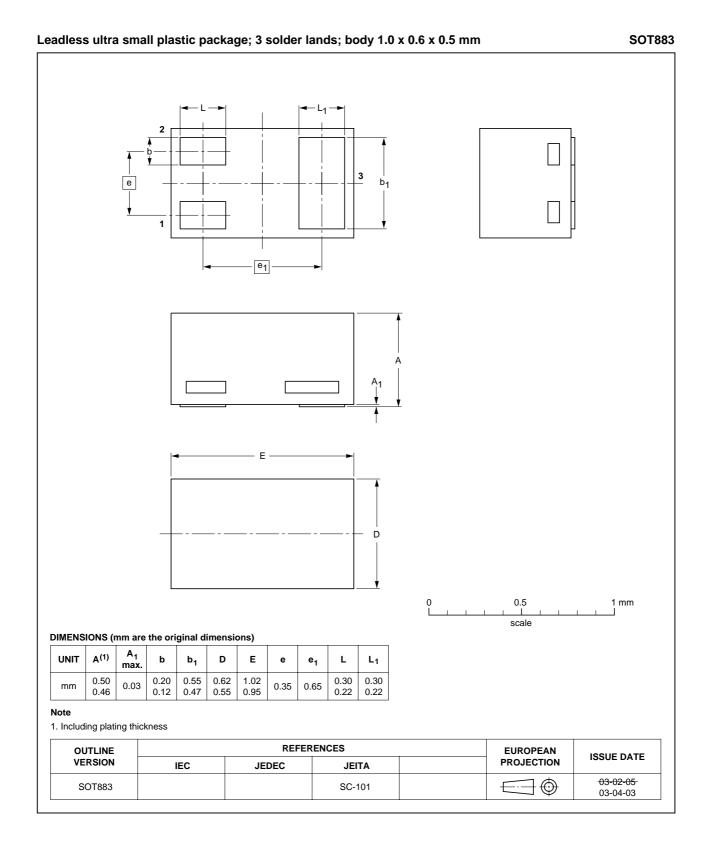
PDTC143T series

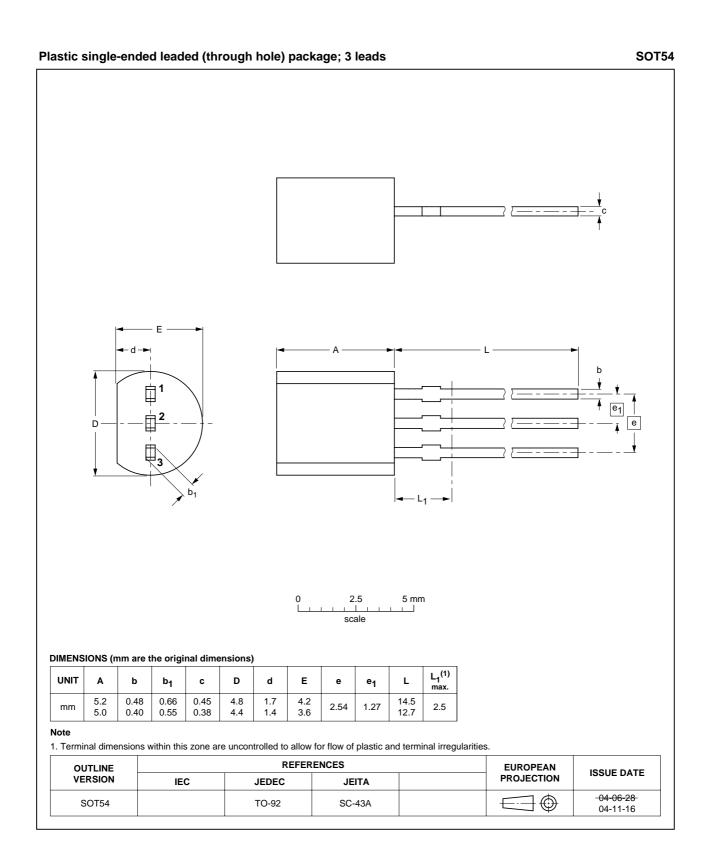
NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$, R2 = open

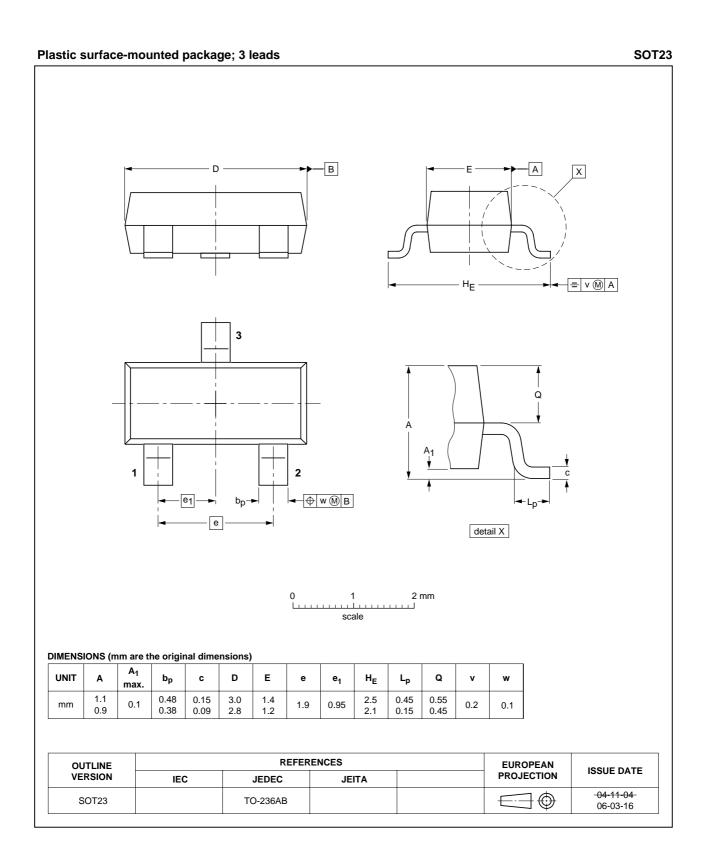
PACKAGE OUTLINES

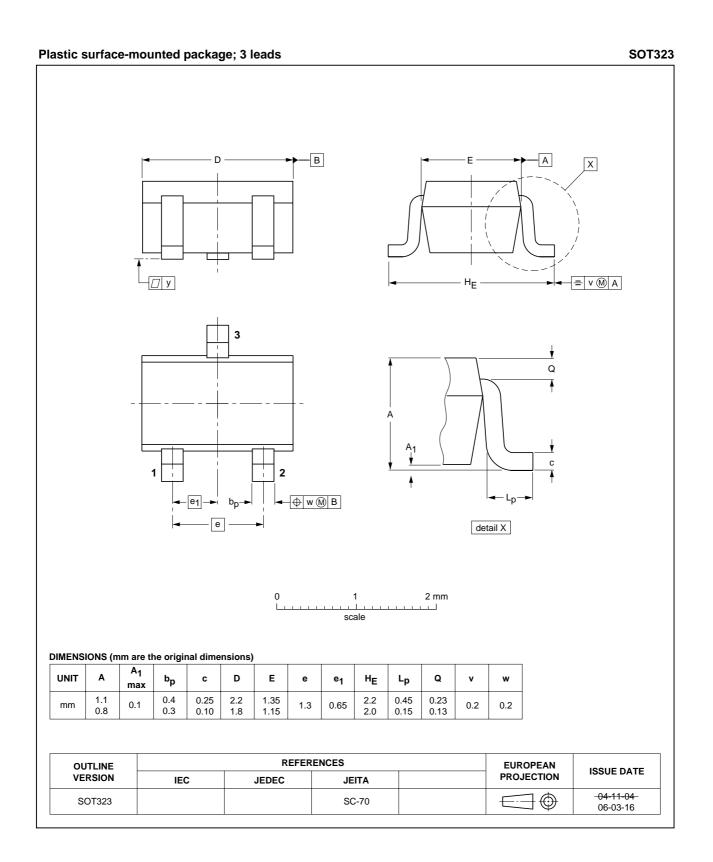


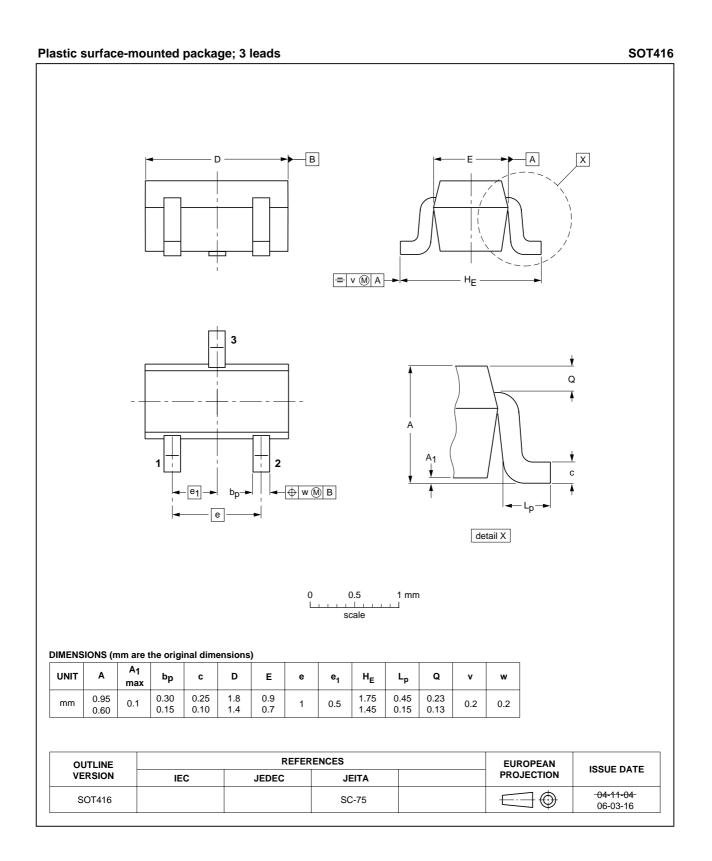












PDTC143T series

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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